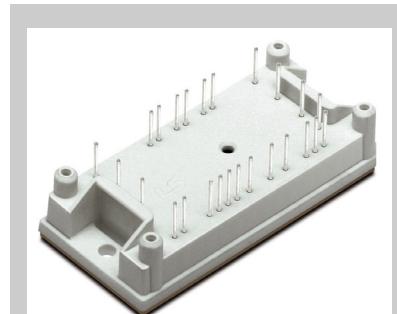


Features

- Trench Field Stop technology IGBT adopted
- Low saturation voltage
- Positive temperature coefficient
- Fast switching
- Free wheeling diodes with fast and soft reverse recovery
- Industrial standard package with insulated substrate
- Temperature sensor included

Preliminary Data

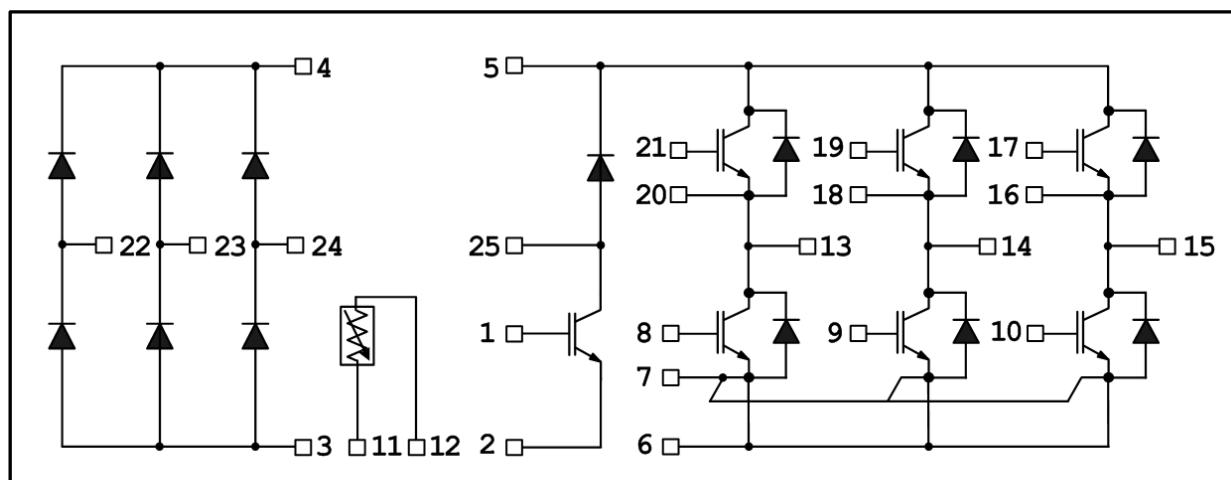

SISPM1

82.2 x 37.9 x 21.7mm

Applications

- Input from single or three phase grid
- Three phase synchronous or asynchronous motor
- Dynamic braking operation

Internal Equivalent Circuit



Pin Description

Pin Number	Pin Name	Pin Description
1	GB	Gate Input for Braking IGBT
2	EB	Emitter Input for Braking IGBT
3	DCN	Negative DC Link Output
4	DCP	Positive DC Link Output
5	P	Positive DC Link Input
6	N	Negative DC Link Input
7	COM	Common Supply Ground
8, 9, 10	GUN, GVN, GWN	Gate Input for Low-side U Phase, V Phase, W Phase
11, 12	TH1, TH2	NTC-, NTC+
13, 14, 15	U, V, W	Output for U Phase, V Phase, W Phase
16, 18, 20	EWP, EVP, EUP	Emitter Input for High-side W Phase, V Phase, U Phase
17, 19, 21	GWP, GVP, GUP	Gate Input for High-side W Phase, V Phase, U Phase
22, 23, 24	R, S, T	Input for R Phase, S Phase, T Phase
25	B	Output for Braking

Absolute Maximum Ratings $T_C = 25^\circ\text{C}$ unless otherwise noted

Item	Symbol	Parameter	Conditions	Value	Units
Input Rectifier	V_{RPM}	Repetitive Peak Reverse Voltage		1600	V
	I_{FAV}	Forward Current per Diode	@ $T_j = 150^\circ\text{C}$, $T_C = 80^\circ\text{C}$	15	A
	I_{FSM}	Surge Forward Current (Chip level)	@ $t_p = 10\text{ ms}$, half sine wave	220	A
	I^2t	I^2t - Value (Chip level)	@ $t_p = 10\text{ ms}$, half sine wave	200	A^2s
	P_D	Maximum Power Dissipation	@ $T_j = 150^\circ\text{C}$, $T_C = 80^\circ\text{C}$	40	W
	T_j	Operating Junction Temperature *(1)	-	-40 ~ 125	$^\circ\text{C}$
Transistor Inverter	V_{CES}	Collector-Emitter Breakdown Voltage	-	600	V
	V_{GES}	Gate-Emitter Peak Voltage	-	± 20	V
	I_C	DC Collector Current	@ $T_j = 175^\circ\text{C}$, $T_C = 80^\circ\text{C}$	15	A
	I_{cpulse}	Repetitive Peak Collector Current	@ $t_p = 1\text{ ms}$	30	A
	P_D	Maximum Power Dissipation	@ $T_j = 175^\circ\text{C}$, $T_C = 80^\circ\text{C}$	40	W
	T_{SC}	SC Withstand Time (Chip level)	$V_{GE} = 15\text{ V}$, $V_{CE} = 300\text{ V}$	5	μs
Diode Inverter	T_j	Operating Junction Temperature *(2)	-	-40 ~ 125	$^\circ\text{C}$
	V_{RRM}	Repetitive Peak Reverse Voltage	-	600	V
	I_F	DC Forward Current	@ $T_j = 175^\circ\text{C}$, $T_C = 80^\circ\text{C}$	15	A
	I_{FRM}	Repetitive Peak Forward Current	@ $t_p = 1\text{ ms}$	30	A
	P_D	Maximum Power Dissipation	@ $T_j = 175^\circ\text{C}$, $T_C = 80^\circ\text{C}$	35	W
Transistor Brake	T_j	Operating Junction Temperature *(2)	-	-40 ~ 125	$^\circ\text{C}$
	V_{CES}	Collector-Emitter Breakdown Voltage	-	600	V
	V_{GES}	Gate-Emitter Peak Voltage	-	± 20	V
	I_C	DC Collector Current	@ $T_j = 175^\circ\text{C}$, $T_C = 80^\circ\text{C}$	15	A
	I_{cpulse}	Repetitive Peak Collector Current	@ $t_p = 1\text{ ms}$	30	A
	P_D	Maximum Power Dissipation	@ $T_j = 175^\circ\text{C}$, $T_C = 80^\circ\text{C}$	40	W
Diode Brake	T_{SC}	SC Withstand Time (Chip level)	@ $V_{GE} = 15\text{ V}$, $V_{CE} = 300\text{ V}$	5	μs
	T_j	Operating Junction Temperature *(2)	-	-40 ~ 125	$^\circ\text{C}$
	V_{RRM}	Repetitive Peak Reverse Voltage	-	600	V
	I_F	DC Forward Current	@ $T_j = 175^\circ\text{C}$, $T_C = 80^\circ\text{C}$	15	A
	I_{FRM}	Repetitive Peak Forward Current	@ $t_p = 1\text{ ms}$	30	A
Module	P_D	Maximum Power Dissipation	@ $T_j = 175^\circ\text{C}$, $T_C = 80^\circ\text{C}$	35	W
	T_{stg}	Storage Temperature	-	-40~125	$^\circ\text{C}$
	V_{iso}	Isolation Voltage	@ AC 1minute	2500	V
	W	Weight	-	50	g

(Note *1) The Maximum junction temperature of chip is 150°C .
 (Note *2) The Maximum junction temperature of chip is 175°C .

LEC15G604

Electrical Characteristics $T_C = 25^\circ\text{C}$ unless otherwise noted

Input Rectifier Characteristics

Symbol	Parameter	Conditions	Min	Typ	Max	Units
V_F	Diode Forward Voltage	$T_C = 25^\circ\text{C}, I_F = 15 \text{ A}$	-	1.1	-	V
		$T_C = 125^\circ\text{C}, I_F = 15 \text{ A}$	-	1.0	-	V
V_{to}	Threshold Voltage	$T_C = 125^\circ\text{C}$	-	0.83	-	V
I_R	Reverse Current (Chip level)	$T_C = 25^\circ\text{C}, V_{RRM} = 300 \text{ V}$	-	0.1	-	mA
r_t	Slope Resistance	$T_C = 125^\circ\text{C}$	-	20.8	-	$\text{m}\Omega$
$R_{th(J-C)}$	Thermal Resistance (IGBT Part)	Junction-to-Case	-	1.3	-	$^\circ\text{C}/\text{W}$

Transistor-Inverter Characteristics

Symbol	Parameter	Conditions	Min	Typ	Max	Units
$V_{GE(th)}$	Gate-Emitter threshold Voltage	$V_{CE} = V_{GE}, I_{CE} = 15 \text{ mA}$	-	6.5	-	V
$V_{CE(sat)}$	Collector-Emitter Saturation Voltage	$T_C = 25^\circ\text{C}, I_{CE} = 15 \text{ A}, V_{GE} = 15 \text{ V}$	-	1.95	-	V
		$T_C = 125^\circ\text{C}, I_{CE} = 15 \text{ A}, V_{GE} = 15 \text{ V}$	-	2.35	-	V
I_{CES}	Collector-Emitter Cut-off Current	$V_{GE} = 0 \text{ V}, V_{CE} = 300 \text{ V}$	-	-	250	μA
I_{CES}	Gate-Emitter Leakage Current	$V_{GE} = \pm 20 \text{ V}, V_{CE} = 0 \text{ V}$	-	-	-	A
C_{iss}	Input Capacitance	$V_{CE} = 50 \text{ V}, V_{GE} = 0 \text{ V}$	-	-	-	nF
C_{oss}	Output Capacitance	$f = 100 \text{ kHz}, T_C = 25^\circ\text{C}$	-	-	-	nF
C_{rss}	Reverse Transfer Capacitance	(Chip level)	-	-	-	nF
$t_d(on)$	Turn-On Delay Time		-	64	-	ns
t_r	Rise Time		-	43	-	ns
$t_d(off)$	Turn-Off Delay Time		-	82	-	ns
t_f	Fall Time		-	96	-	ns
E_{on}	Turn-On Switching Loss		-	0.55	-	mJ
E_{off}	Turn-Off Switching Loss		-	0.21	-	mJ
E_{ts}	Total Switching Loss		-	0.76	-	mJ
Q_G	Total Gate Charge		-	43	-	nC
Q_{GE}	Gate-Emitter Charge		-	21	-	nC
Q_{GC}	Gate-Collector Charge		-	12	-	nC
$R_{th(J-C)}$	Thermal Resistance (IGBT Part)	Junction-to-Case	-	1.8	-	$^\circ\text{C}/\text{W}$

Diode-Inverter Characteristics $T_C = 25^\circ\text{C}$ unless otherwise noted

Symbol	Parameter	Conditions	Min	Typ	Max	Units	
V_F	Diode Forward Voltage	$I_F = 15 \text{ A}, V_{GE} = 0 \text{ V}$	$T_C = 125^\circ\text{C}$	-	1.5	-	V
t_{rr}	Diode Reverse Recovery Time		$R_{G\ ON} = 40 \Omega$	-	282	-	ns
I_{RRM}	Diode Peak Reverse Recovery Current		$L = 500 \mu\text{H}$	-	15.3	-	A
Q_{rr}	Diode Reverse Recovery Charge		$V_{CE} = 300 \text{ V}$	-	1.6	-	μC
E_{rr}	Diode Reverse Recovery Energy		$V_{GE} = 0 \text{ V} \sim 15 \text{ V}$	-	0.28	-	mJ
I_{CE}		$I_{CE} = 15 \text{ A}$	$T_C = 125^\circ\text{C}$	-	-	-	
$R_{th(J-C)}$	Thermal Resistance (IGBT Part)	Junction-to-Case	-	2.1	-	$^\circ\text{C}/\text{W}$	

Transistor- Brake Characteristics

Symbol	Parameter	Conditions	Min	Typ	Max	Units
$V_{GE(th)}$	Gate-Emitter Threshold Voltage	$V_{CE} = V_{GE}, I_{CE} = 15 \text{ mA}$	-	6.5	-	V
$V_{CE(sat)}$	Collector-Emitter Saturation Voltage	$T_C = 25^\circ\text{C}, I_{CE} = 15 \text{ A}, V_{GE} = 15 \text{ V}$	-	1.95	-	V
		$T_C = 125^\circ\text{C}, I_{CE} = 15 \text{ A}, V_{GE} = 15 \text{ V}$	-	2.35	-	V
I_{CES}	Collector-Emitter Cut-off Current	$V_{GE} = 0 \text{ V}, V_{CE} = 300 \text{ V}$	-	-	250	μA
I_{CES}	Gate-Emitter Leakage Current	$V_{GE} = \pm 20 \text{ V}, V_{CE} = 0 \text{ V}$	-	-	-	A
C_{iss}	Input Capacitance	$V_{CE} = 50 \text{ V}, V_{GE} = 0 \text{ V}$	-	-	-	nF
C_{oss}	Output Capacitance	$f = 100 \text{ kHz}, T_C = 25^\circ\text{C}$	-	-	-	nF
C_{rss}	Reverse Transfer Capacitance	(Chip level)	-	-	-	nF

Symbol	Parameter	Conditions	Min	Typ	Max	Units
$t_{d(on)}$	Turn-On Delay Time	$T_C = 125^\circ C$, $R_{G\ ON} = 40\ \Omega$ $R_{G\ OFF} = 20\ \Omega$, $L = 500\ \mu H$ $V_{CE} = 300\ V$, $V_{GE} = 0\ V \sim 15\ V$ $I_{CE} = 15\ A$	-	68	-	ns
t_r	Rise Time		-	54	-	ns
$t_d(off)$	Turn-Off Delay Time		-	86	-	ns
t_f	Fall Time		-	106	-	ns
E_{on}	Turn-On Switching Loss		-	0.65	-	mJ
E_{off}	Turn-Off Switching Loss		-	0.19	-	mJ
E_{ts}	Total Switching Loss		-	0.84	-	mJ
Q_G	Total Gate Charge		-	43	-	μC
Q_{GE}	Gate-Emitter Charge	$V_{GE} = 0\ V \sim 15\ V$	-	21	-	μC
Q_{GC}	Gate-Collector Charge		-	12	-	μC
$R_{th(J-C)}$	Thermal Resistance (IGBT Part)	Junction-to-Case	-	1.8	-	$^\circ C/W$

Diode-Brake Characteristics $T_C = 25^\circ C$ unless otherwise noted

Symbol	Parameter	Test Conditions		Min	Typ	Max	Units	
V_F	Diode Forward Voltage	$I_F = 15\ A$	$V_{GE} = 0\ V$	$T_C = 125^\circ C$	-	1.5	-	V
t_{rr}	Diode Reverse Recovery Time	$R_{G\ ON} = 40\ \Omega$ $L = 500\ \mu H$ $V_{CE} = 300\ V$ $V_{GE} = 0\ V \sim 15\ V$ $I_{CE} = 15\ A$	$T_C = 125^\circ C$	-	415	-	ns	
I_{RRM}	Diode Peak Reverse Recovery Current		$T_C = 125^\circ C$	-	11.3	-	A	
Q_{rr}	Diode Reverse Recovery Charge		$T_C = 125^\circ C$	-	1.6	-	μC	
E_{rr}	Diode Reverse Recovery Energy		$T_C = 125^\circ C$	-	0.33	-	mJ	
$R_{th(J-C)}$	Thermal Resistance (IGBT Part)	Junction-to-Case		-	2.1	2.5	$^\circ C/W$	

NTC thermistor Characteristics

Symbol	Parameter	Test Conditions		Min	Typ	Max	Units
R_{25}	Resistance	$T_C = 25^\circ C$		-	4.7	-	k Ω
P	Power	$T_C = 25^\circ C$		-	210	-	mW
$B_{25/100}$	B Constant	$T_C = 25^\circ C$, $\pm 3\%$ tolerance		-	3650	-	K

* This specifications may not be considered as an assurance of characteristics and may not have same characteristics.
in case of using different test systems from @LSIS. We therefore strongly recommend prior consultation of our engineers.

LEC15G604

Input rectifier

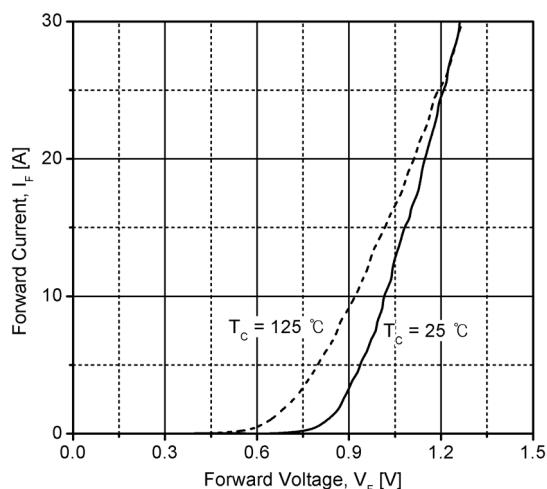


Fig 1. Typical Diode Forward Characteristics

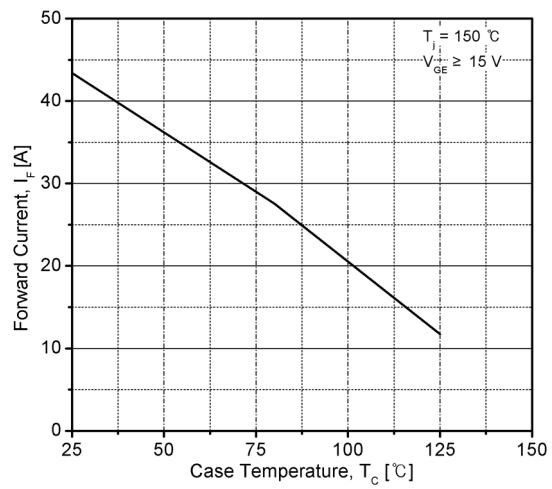


Fig 2. Case Temperature vs. Forward Current

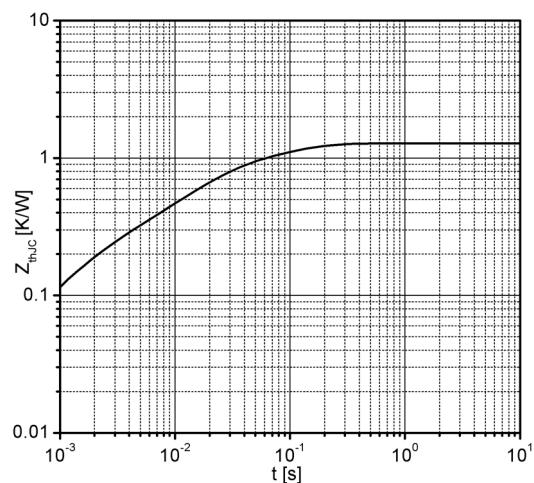


Fig 3. Typical Diode Thermal Impedance

Transistor-inverter/Diode-Inverter

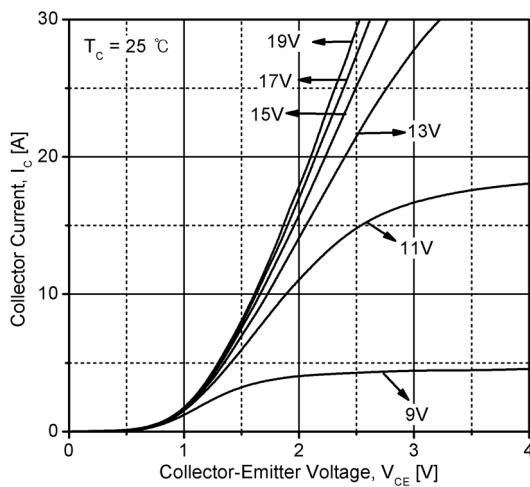


Fig 4. Typical IGBT Output Characteristics

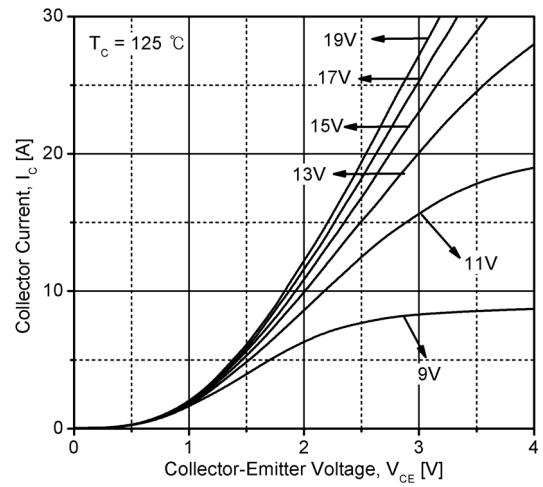


Fig 5. Typical IGBT Output Characteristics

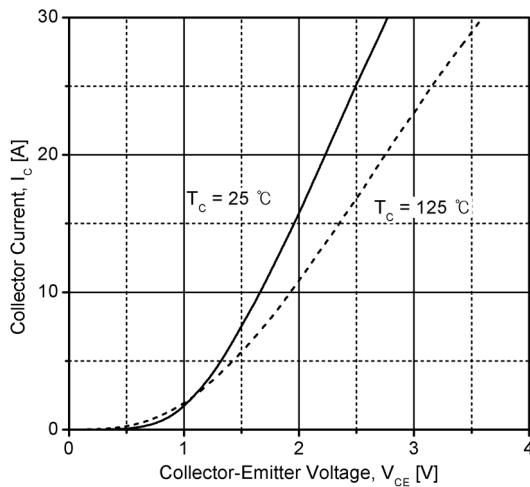


Fig 6. Typical IGBT Output Characteristics

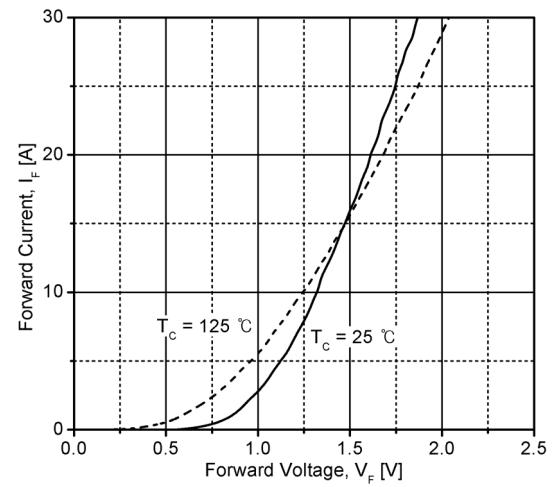


Fig 7. Typical Diode Forward Characteristics

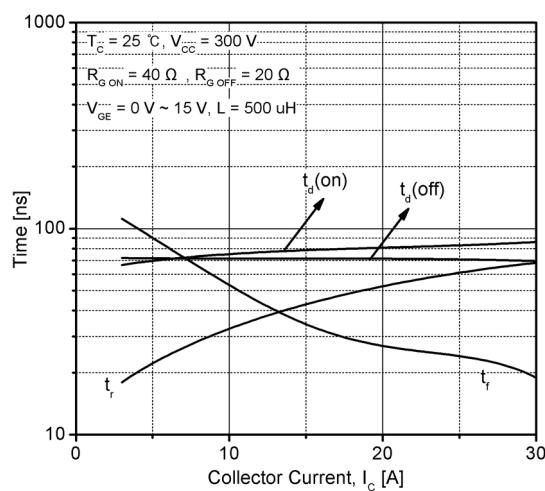


Fig 8. Typical Switching Time vs. Collector Current

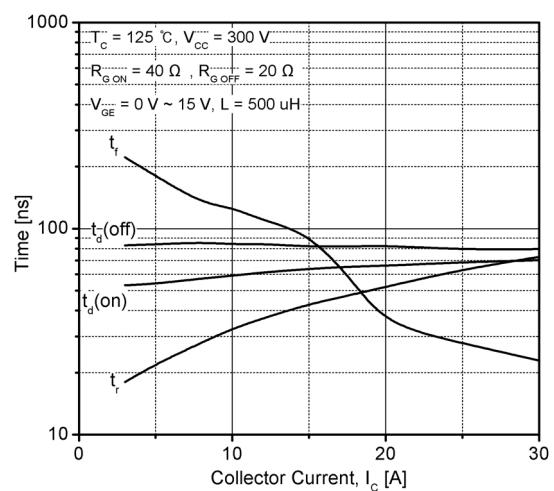


Fig 9. Typical Switching Time vs. Collector Current

LEC15G604

Transistor-inverter/Diode-Inverter

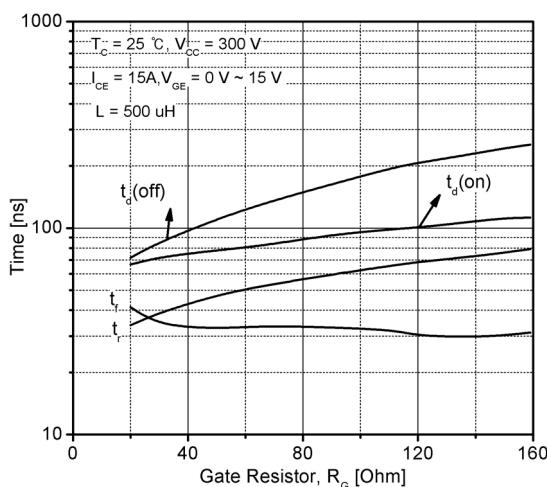


Fig 10. Typical Switching Time vs. Gate Resistor

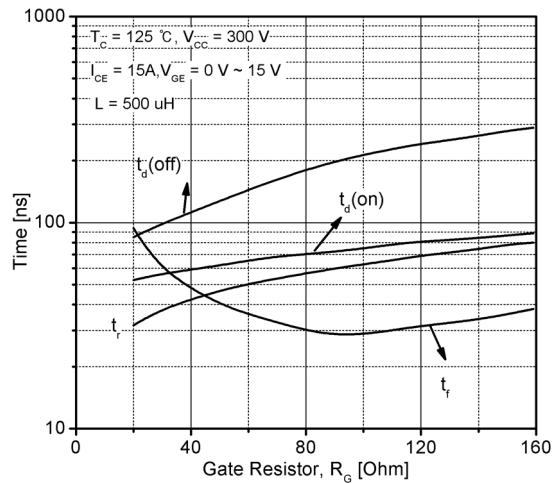


Fig 11. Typical Switching Time vs. Gate Resistor

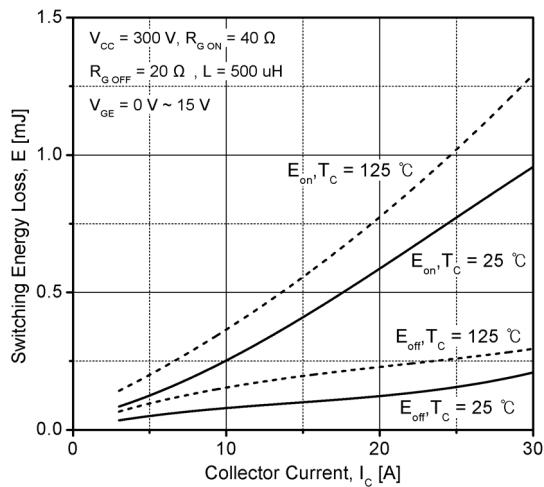


Fig 12. Typical IGBT Switching Loss

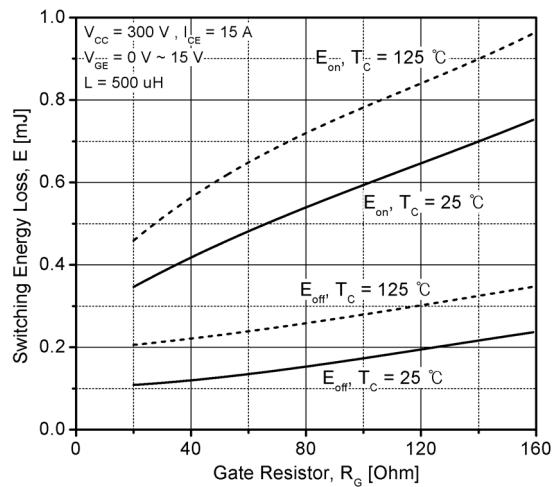


Fig 13. Typical IGBT Switching Loss

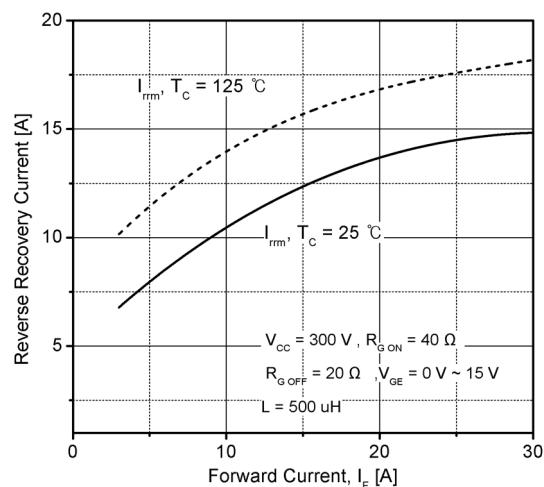


Fig 14. Typical Recovery Characteristics of Diode

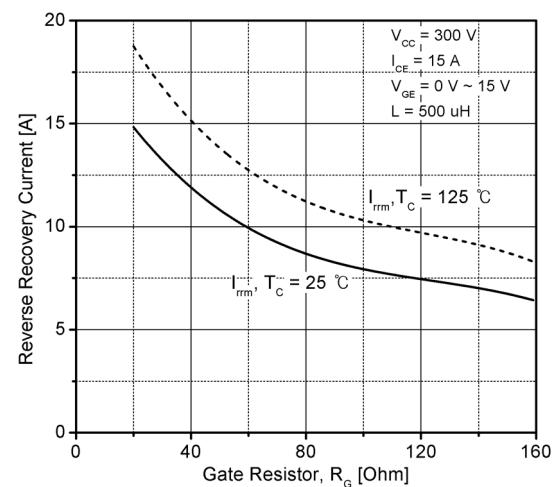


Fig 15. Typical Recovery Characteristics of Diode

Transistor-inverter/Diode-Inverter

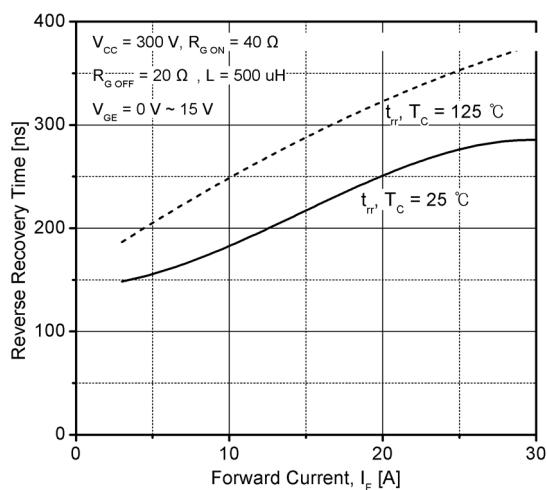


Fig 16. Typical Recovery Characteristics of Diode

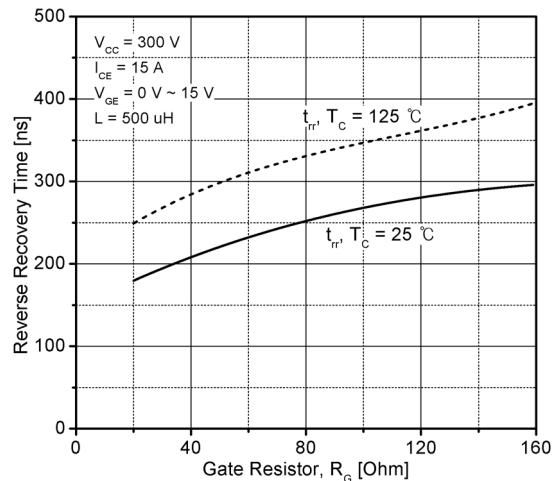


Fig 17. Typical Recovery Characteristics of Diode

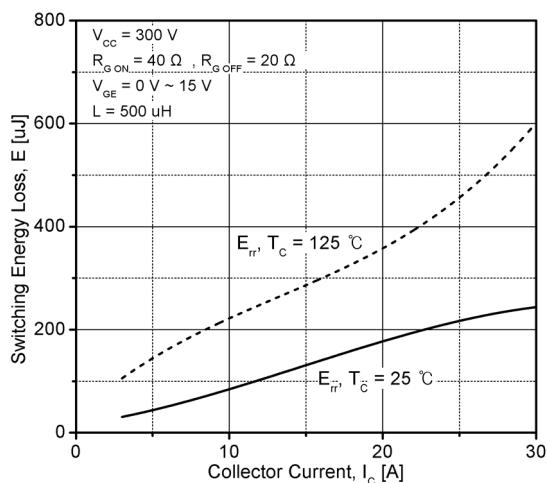


Fig 18. Typical Diode Switching Loss

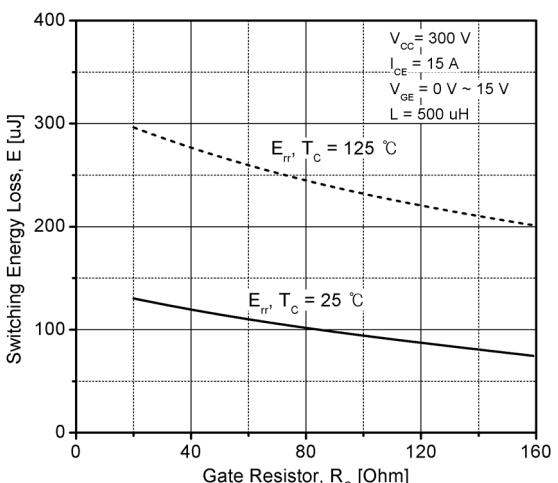


Fig 19. Typical Diode Switching Loss

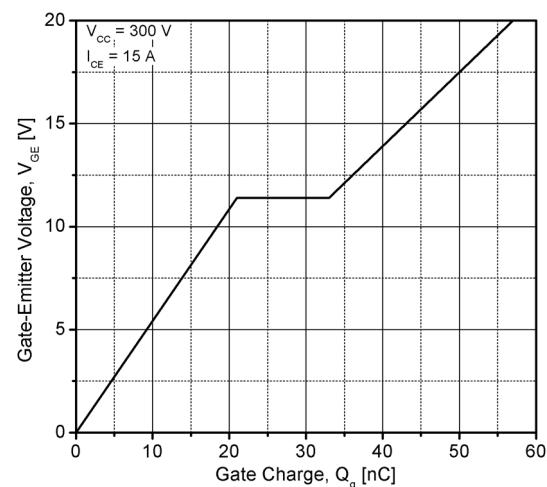


Fig 20. Typical Gate Charge Characteristics

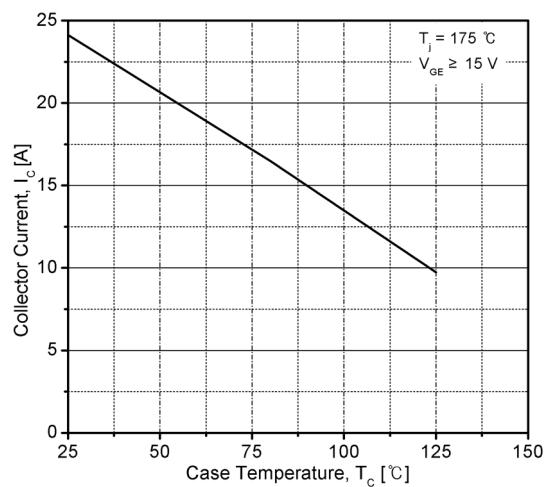


Fig 21. Case Temperature vs. Collector Current

LEC15G604

Transistor-inverter/Diode-Inverter

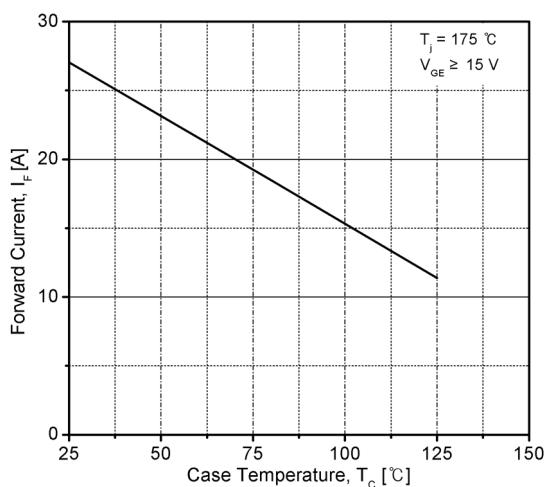


Fig 22. Case Temperature vs. Forward Current

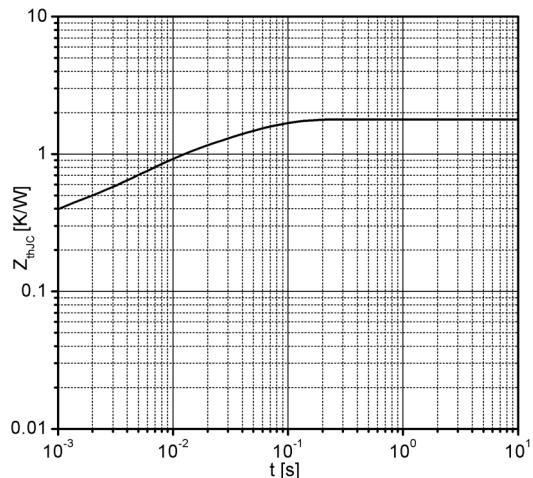


Fig 23. Typical IGBT Thermal Impedance

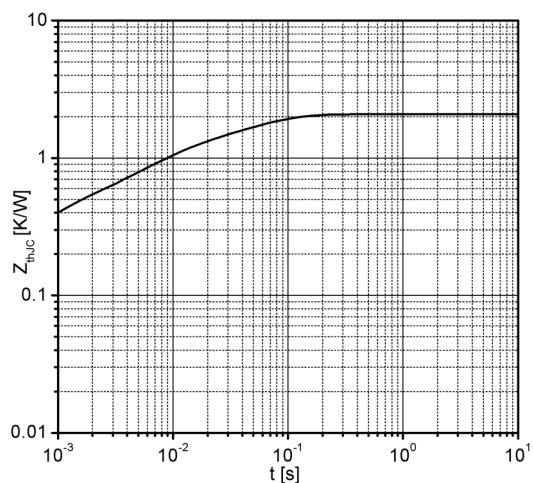


Fig 24. Typical Diode Thermal Impedance

Transistor-Brake/Diode-Brake

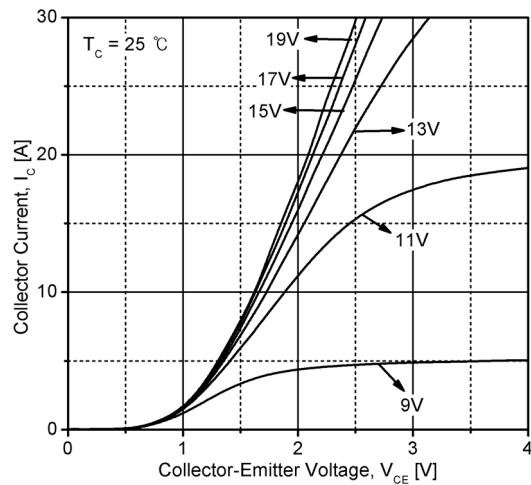


Fig 25. Typical IGBT Output Characteristics

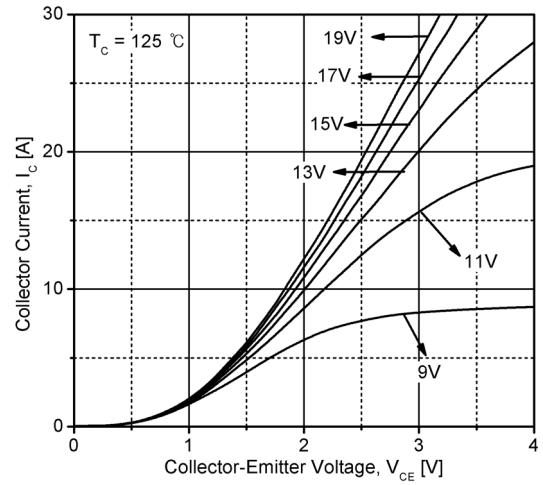


Fig 26. Typical IGBT Output Characteristics

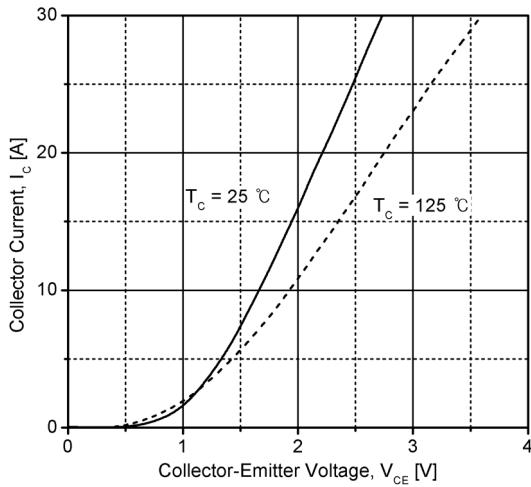


Fig 27. Typical IGBT Output Characteristics

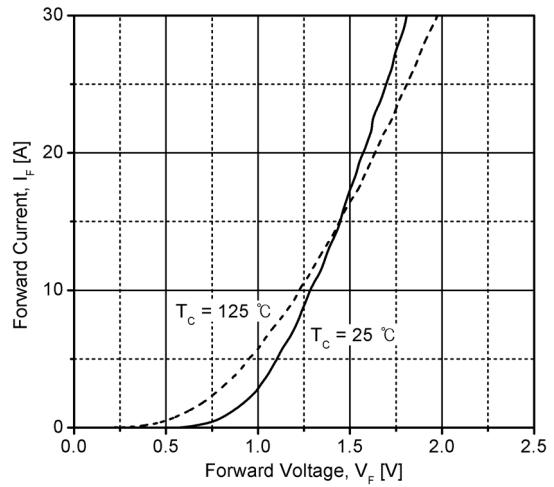


Fig 28. Typical Diode Forward Characteristics

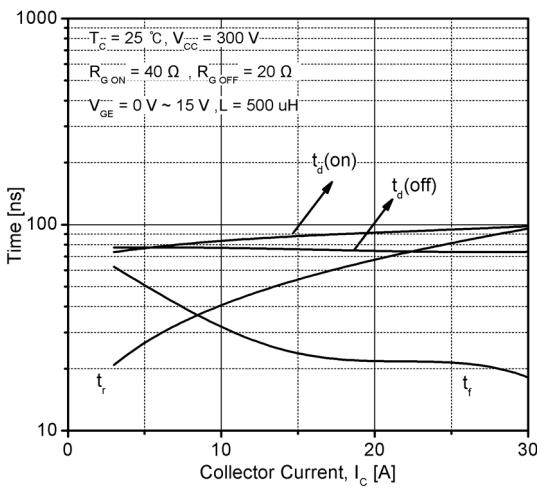


Fig 29. Typical Switching Time vs. Collector Current

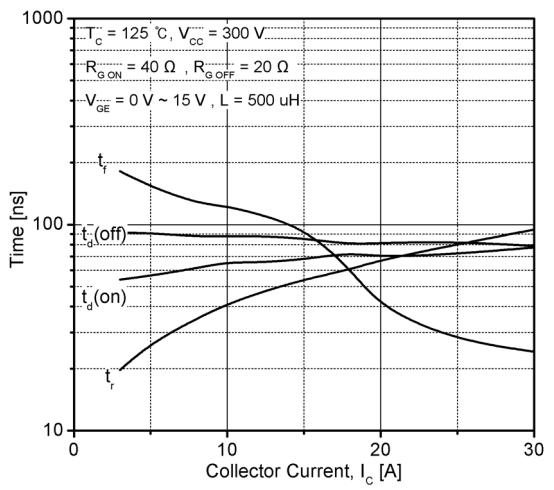


Fig 30. Typical Switching Time vs. Collector Current

LEC15G604

Transistor-Brake/Diode-Brake

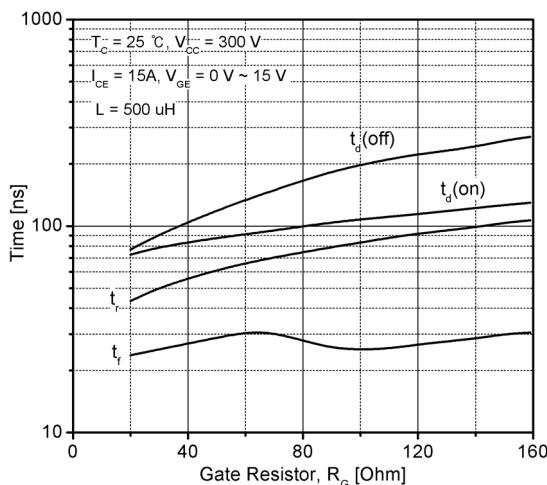


Fig 31. Typical Switching Time vs. Gate Resistor

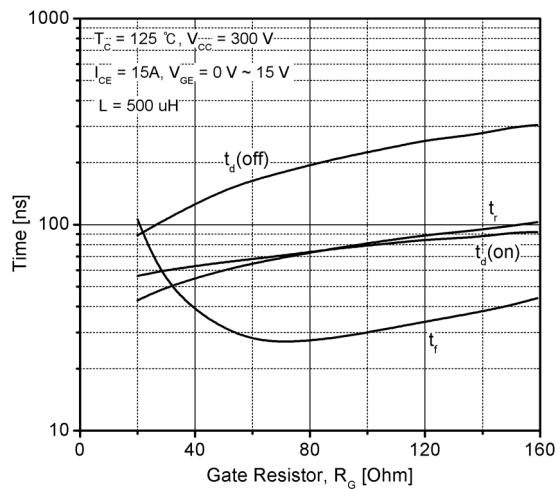


Fig 32. Typical Switching Time vs. Gate Resistor

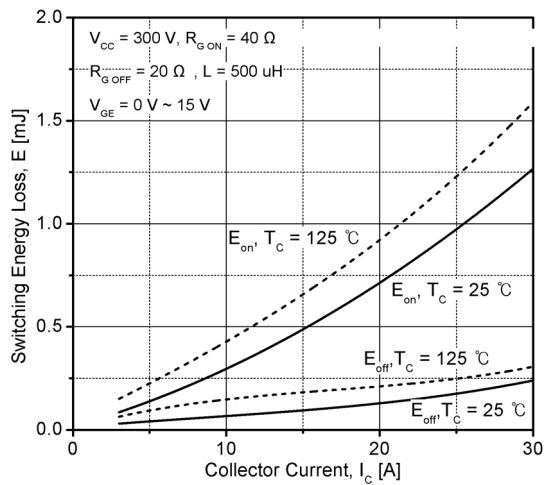


Fig 33. Typical IGBT Switching Loss

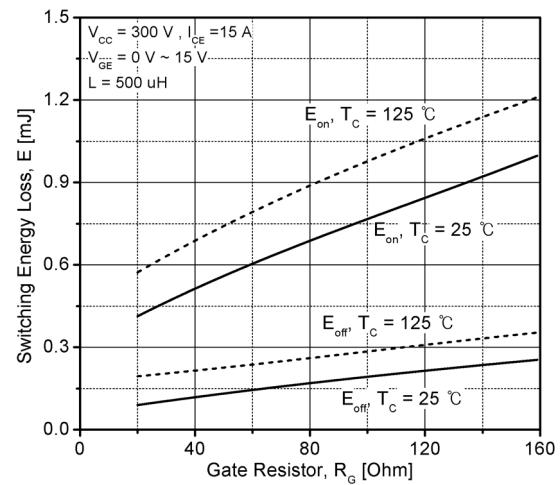


Fig 34. Typical IGBT Switching Loss

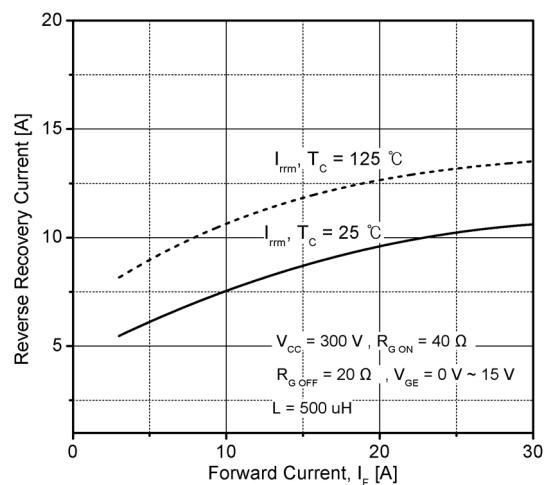


Fig 35. Typical Recovery Characteristics of Diode

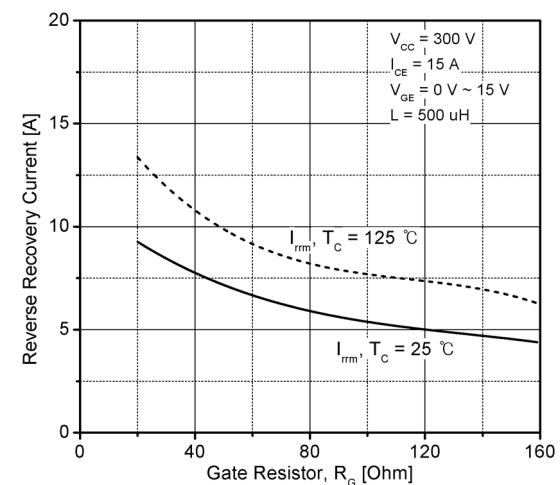


Fig 36. Typical Recovery Characteristics of Diode

Transistor-Brake/Diode-Brake

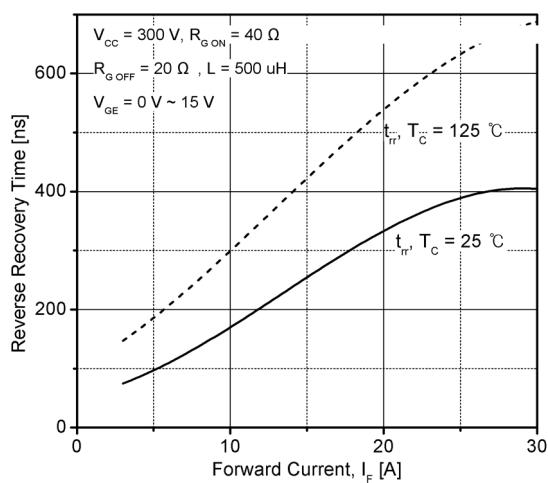


Fig 37. Typical Recovery Characteristics of Diode

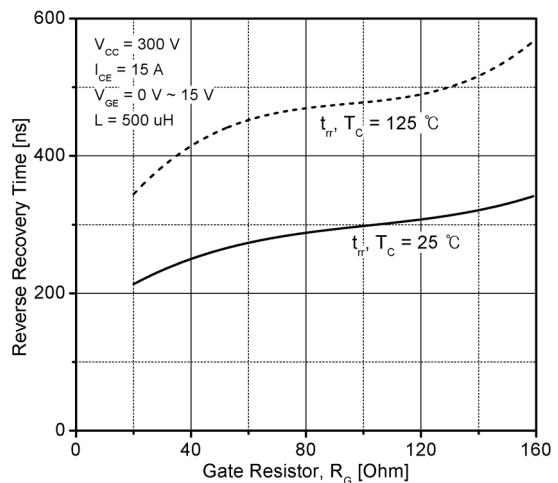


Fig 38. Typical Recovery Characteristics of Diode

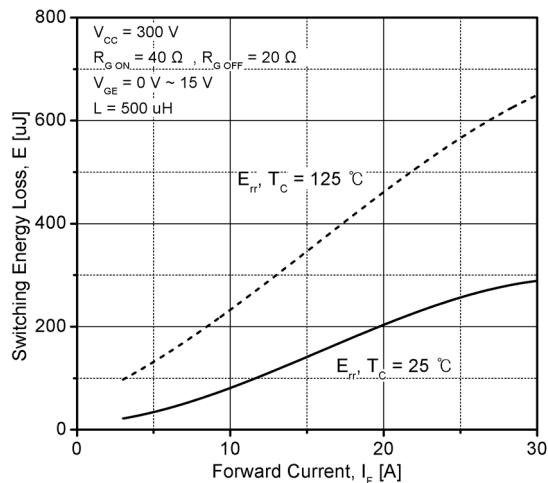


Fig 39. Typical Diode Switching Loss

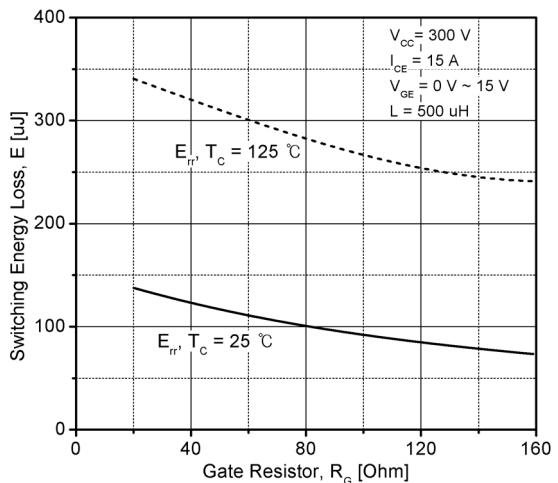


Fig 40. Typical Diode Switching Loss

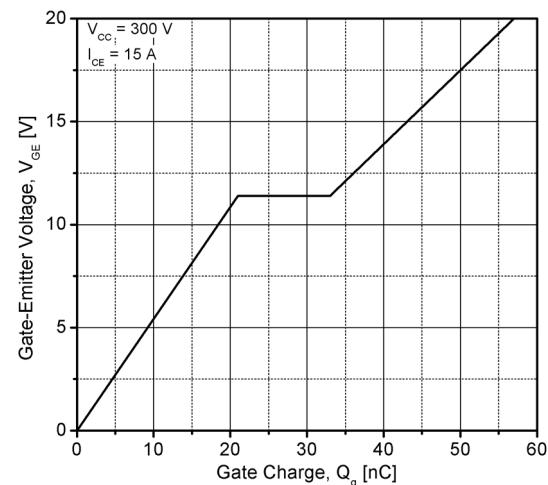


Fig 41. Typical Gate Charge Characteristics

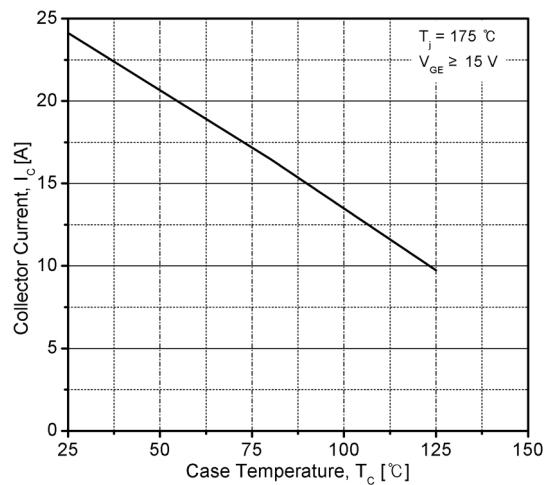


Fig 42. Case Temperature vs. Collector Current

LEC15G604

Transistor-Brake/Diode-Brake

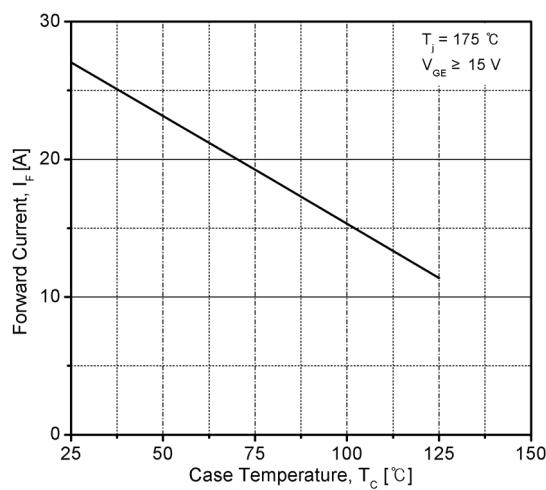


Fig 43. Case Temperature vs. Forward Current

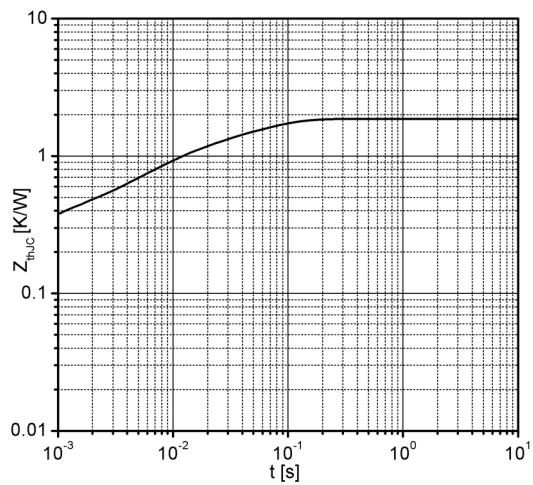


Fig 44. Typical IGBT Thermal Impedance

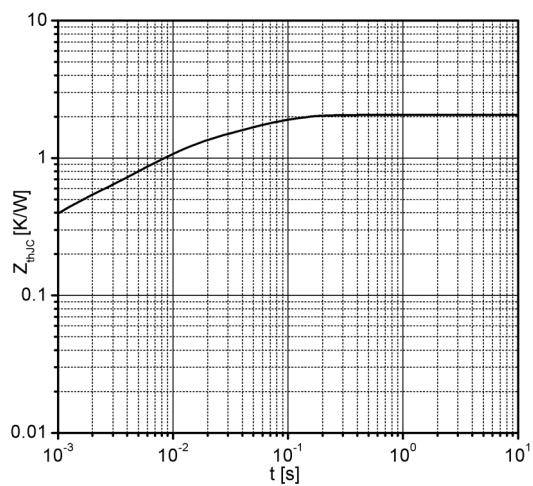


Fig 45. Typical Diode Thermal Impedance

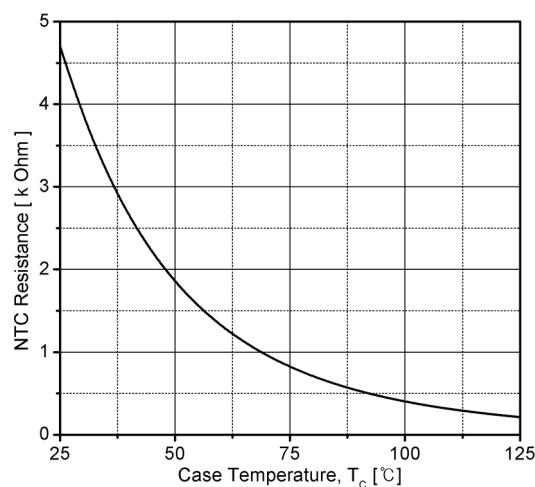
NTC

Fig 46. Typical NTC Characteristics

LEC15G604

Package Dimension(Dimension in mm)

